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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO	
10/628,614	07/28/2003	Roger Y. B. Young	03-0460	03-0460 4439	
24319	7590 07/13/2005		EXAMINER		
LSI LOGIC CORPORATION			LE, QUE TAN		
1621 BARBE	R LANE				
MS: D-106			ART UNIT .	PAPER NUMBER	
MILPITAS, C	CA 95035		2878	2878	
			DATE MAIL ED. 07/12/2006	•	

DATE MAILED. 07/13/2003

Please find below and/or attached an Office communication concerning this application or proceeding.

			AK
	Application No.	Applicant(s)	
	10/628,614	YOUNG ET AL.	
Office Action Summary	Examiner	Art Unit	
	Que T. Le	2878	
The MAILING DATE of this communication app Period for Reply	ears on the cover sheet with the c	correspondence ac	ldress
A SHORTENED STATUTORY PERIOD FOR REPLY THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a reply - If NO period for reply is specified above, the maximum statutory period w - Failure to reply within the set or extended period for reply will, by statute, Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	36(a). In no event, however, may a reply be tin within the statutory minimum of thirty (30) day ill apply and will expire SIX (6) MONTHS from cause the application to become ABANDONE	nely filed s will be considered time the mailing date of this c D (35 U.S.C. § 133).	
Status			
1) Responsive to communication(s) filed on	:		
2a) ☐ This action is FINAL. 2b) ☒ This	action is non-final.		
3) Since this application is in condition for allowar	·		e merits is
closed in accordance with the practice under E	x parte Quayle, 1935 C.D. 11, 49	53 O.G. 213.	
Disposition of Claims			
4) Claim(s) 1-20 is/are pending in the application. 4a) Of the above claim(s) is/are withdray 5) Claim(s) is/are allowed. 6) Claim(s) 1-20 is/are rejected. 7) Claim(s) is/are objected to. 8) Claim(s) are subject to restriction and/or	vn from consideration.		
Application Papers			
9) The specification is objected to by the Examine 10) The drawing(s) filed on 28 July 2003 is/are: a) Applicant may not request that any objection to the Replacement drawing sheet(s) including the correction of the oath or declaration is objected to by the Examine 11).	☑ accepted or b)☐ objected to the disconnected in abeyance. Set on is required if the drawing(s) is objected to the drawing(s) is objected in the drawing(s) is objected to the drawing(s	e 37 CFR 1.85(a). jected to. See 37 C	
Priority under 35 U.S.C. § 119			
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1. Certified copies of the priority documents 2. Certified copies of the priority documents 3. Copies of the certified copies of the priori	s have been received. s have been received in Applicati ity documents have been receive ı (PCT Rule 17.2(a)).	on No ed in this National	Stage
Attachment(s)			
Notice of References Cited (PTO-892) Notice of Draftsperson's Patent Drawing Review (PTO-948) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail Do 5) Notice of Informal F 6) Other:	ate	O-152)

Application/Control Number: 10/628,614

Art Unit: 2878

The title of the invention is not descriptive. A new title is required that is clearly indicative of the invention to which the claims are directed.

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(e) the invention was described in (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent or (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effects for purposes of this subsection of an application filed in the United States only if the international application designated the United States and was published under Article 21(2) of such treaty in the English language.

This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary. Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).

Claims 1-4, 8, 9 and 16 are rejected under 35 U.S.C. 102(e) as being anticipated by Tsuii 6,906,794.

Tsuji discloses a semiconductor wafer inspection system comprising: an image capturing device (100, a microscope with a review system) to view at least a portion of an edge of the wafer (2) and generating an image of the edge of the wafer; a database (77, 78) receiving the generated image and storing the received image for subsequent

analysis; and a computer (75) to retrieve the stored image upon instructions from a user/operator to perform image analysis to locate any defects in the edge of the wafer (column 6). Tsuji also discloses the method of operation including setting an angle of the image capturing device relative to the edge of the wafer, magnification of the device, focus of the device, brightness of an illumination source, and the rotational speed of the wafer (columns 4-7). The Tsuji's system inherently performs the claimed method steps.

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 5-7, 10-15 and 17-20 are rejected under 35 U.S.C. 103(a) as being unpatentable over Tsuji 6,906,794.

With respect to claim 5, although Tsuji lacks a clear inclusion of scanning the edge of the wafer from a region interior of a top to a region exterior of a bottom of the edge, selecting a specific manner for scanning an object to be inspected or a wafer for providing a specific pattern of image to be taken by the image capturing device would have been obvious to one of ordinary skill in the art. It would have been obvious to modify Tsuji accordingly in order to provide a better image pattern to be recorded or stored or displayed, if so desired.

With respect to claims 6 and 7, although Tsuji lacks a clear inclusion of comparing the previous defect information to the after defect information to locate any

added defects and/or any repaired defects, repeatedly inspecting the same area or portion of an inspected object or wafer for ensuring a complete inspection performance would have been obvious to one of ordinary skill in the inspection art. It would have been obvious to one of ordinary skill in the art at the time of the invention to modify Tsuji accordingly in order to provide a more reliable inspection performance of the system.

Regarding claims 10-15, although Tsuji discloses different scenarios during the operation of the system but lacks a clear inclusion of an inspection during fabrication of integrated circuit components on the wafer, and a plurality of inspection stations within the fabrication system, it would have been inherently included (columns 1-2), however, if not, it would have been obvious to one of ordinary skill in the art at the time of the invention to modify Tsuji accordingly in order to provide a faster production line for making a semiconductor wafer.

Regarding claims 17-20, the inclusion of a second image capturing device would have been an obvious aggregation to one of ordinary skill in the art, thus, it would have been obvious for one of ordinary skill in the art at the time of the invention to modify the proposed system of Tsuji, discussed in the discussion of claims 10-15 above, for similar reasons set forth above. The inclusion of the determination of any added defects and/or repaired defects would have been obvious for similar reasons set forth in the discussion of claims 6 and 7 above.

The prior art made of record and not relied upon is considered pertinent to applicant's disclosure.

Art Unit: 2878

I) Park 6,432,800 discloses a wafer inspection system during a fabrication process having an image capturing device and a data processing unit.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Que T. Le whose telephone number is (571) 272-2438.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, David P. Porta, can be reached on (571) 272-2444. The fax phone number for the organization where this application or proceeding is assigned is (703) 872-9306.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is (703) 308-0956.

Que T. Le

Primary Examiner